

Receipt



Practitioner's Docket No. MI22-1332

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Prere application of: Honeycutt et al, Jeffrey W.

Application No.: 09/651,422

Group No.: 2811

Filed: 08/30/2000

Examiner: Unknown

For: Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures

Assistant Commissioner for Patents  
Washington, D.C. 20231

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Date: 3/7/01

Jennifer Gaines  
(type or print name of person certifying)

(Request for Corrected Filing Receipt--page 1 of 2)

**Error in**

1. Title

**Correct data**

1. Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures

3. The correction is not due to any error by applicant and no fee is due.

Date: 3/7/01



David G. Latwesen, Ph.D.  
Reg. No. 38,533  
**Wells, St. John, Roberts, Gregory & Matkin P.S.**  
601 West First Avenue, Suite 1300  
Spokane, WA 99201  
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/651,422	08/30/2000	2811	1252	M122-1332	9	31	6

021567

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SUITE 1300  
601 W FIRST AVENUE  
SPOKANE, WA 992013828



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\*OC000000005798156\*

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Applicant(s)

Jeffrey W. Honeycutt, Boise, ID ;  
Hassan Shahjamali, Boise, ID ;  
Daniel Smith, Boise, ID ;

Continuing Data as Claimed by Applicant

Foreign Applications

If Required, Foreign Filing License Granted 10/19/2000

Title

↓ Structures  
Transistor structures, methods of forming transistor structures, and methods of forming insulative material against conductive Structures

Preliminary Class

257

Data entry by : MASON, JAMES

Team : OIPE

Date: 02/26/2001

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Bib Data Sheet

CONFIRMATION NO. 9935

<b>SERIAL NUMBER</b> 09/651,422	<b>FILING DATE</b> 08/30/2000 <b>RULE</b>	<b>CLASS</b>	<b>GROUP ART UNIT</b> 2899	<b>ATTORNEY DOCKET NO.</b> M122-1332
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APPLICANTS

Jeffrey W. Honeycutt, Boise, ID;  
Hassan Shahjamali, Boise, ID;  
Daniel Smith, Boise, ID;

\*\* CONTINUING DATA \*\*\*\*\* none gic

\*\* FOREIGN APPLICATIONS \*\*\*\*\* none 94

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\*\* 10/19/2000

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 9	TOTAL CLAIMS 31	INDEPENDENT CLAIMS 6
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged <i>J. Kennedy</i> Examiner's Signature Initials				

ADDRESS

021567

TITLE

Transistor structures, methods of forming transistor structures, and methods of forming insulative material against conductive structures

<b>FILING FEE RECEIVED</b> 1252	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing )
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2nd Request for  
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Title still wrong 😞

MI22-1332 (DGL/jg)  
Micron Technology Inc.

11/7/00

The stamp of the U.S. Patent and Trademark Office acknowledges receipt of the following papers relating to the Patent application of Honeycutt, et al. Serial No. 09/651,422, filed 8/30/2000, entitled "Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures".

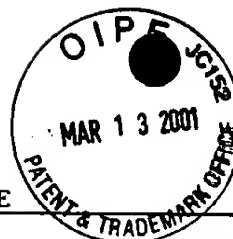
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/651,422	08/30/2000	2811	1122	M122-1332	9	31	6

021567  
WELLS ST JOHN ROBERTS GREGORY AND MATKIN  
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Structures

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Data entry by : MIDDLETON, MATTIE

Team : OIPE

Date: 10/20/2000



Practitioner's Docket No. MI22-1332



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: **Honeycutt et al, Jeffrey W.**

Application No.: 09/965,142

Group No.: 2811

Filed: 08/30/2000

Examiner: Unknown

For: **Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures**

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Office of Initial Patent Examination  
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**SIGNATURE OF PRACTITIONER**

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509-624-4276  
**CUSTOMER NO. 021567**





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**APPLICATION FOR LETTERS PATENT**

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**Transistor Structures, Methods of Forming  
Transistor Structures, and Methods of Forming  
Insulative Material Against Conductive Structures**

**INVENTORS**

Jeffrey W. Honeycutt  
Hassan Shahjamali  
Daniel Smith

ATTORNEY'S DOCKET NO. MI22-1332